

BEST ALUMNI STUDENT

M.Manjusha
VLSI Engineer (Back-End)
Silicon Labs
Bangalore

Package:10LPA

Regd No. – 15NM1A0464

Year of Admission - 2015



Ch.Manasa
VLSI Product Engineer
Intel Corporation, California, USA
Package - \$148K (1,14,68,002 Lac)



Name : Yamuna Prasanna Kumari
Company : Medcover tech
Designation : Senior Quality Engineer
Package : 17 LPA
Year of Admission : 2008



N. Saisha

Fresenius Medical Care in California

Senior Electrical Engineer.

Package : \$155K (1,20,10,407 Per Annum)

Year of Admission : 2008



N.Harika

Tech Mahindra

Tech Lead

Package : 13.5LPA



8X4 Flexi

P.Chandana Sravani

.Net Developer,

HCL





Chennai

Package:8.5 LPA

Regd No. – 15NM1A0495

Year of Admission - 2015



<p>P.Harika Application Associate Engineer Accenture Hyderabad Package : 4.5Lac</p> <p>Regd No. – 17NM1A04G1</p> <p>Year of Admission - 2017</p>	
<p>R.Ramya Associate system Engineer TCS, Hyderabad Package : 3.6Lac</p> <p>Regd No. – 16NM1A04C6</p> <p>Year of Admission - 2016</p>	
<p>M.Niharika Embedded Engineer Safran Aerospace Bangalore Package – 3.9Lac</p> <p>Regd No. – 18NM5A0426</p> <p>Year of Admission - 2017</p>	
<p>Bhargavi Veeraghattam Pursuing Ph.D IIT, Kharagpur Nano Technology</p> <p>Regd No. – 09NM1A0492</p> <p>Year of Admission - 2009</p>	

D.Lalitha Sravani
Embedded Engineer
Visteon corporation Ltd
Bangalore
Package – 4Lac

Regd No. – 14NM1A0430

Year of Admission - 2014



B.Sri Kavya
Associate Software Engineer
Accenture
Hyderabad
Package – 4.5Lac

Regd No. – 17NM1A0418

Year of Admission - 2017



K.Sivani
Java Developer
TCS
Chennai
Package – 3.36LPA

Regd No. – 17NM1A04E8

Year of Admission - 2017

